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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): N. SUZUKI, et al.
Application No.: 10/673,214
Filed: September 30, 2003
Title: MANUFACTURING METHOD OF A SEMICONDUCTOR DEVICE
HAVING PROTECTIVE FILM ON REAR SURFACE OF
SEMICONDUCTOR WAFER (As Amended)
Group: 2823
Examiner: F. Toledo

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 9, 2005

Sir:

In response to the Office Action mailed September 9, 2004, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Specification;

Amendments to the Claims; and

Remarks are included following the amendments.

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